

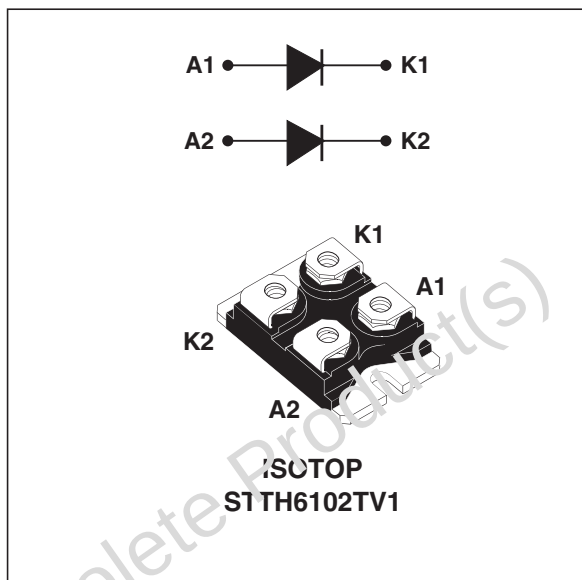
HIGH EFFICIENCY ULTRAFAST DIODE

MAIN PRODUCT CHARACTERISTICS

$I_{F(AV)}$	2 x 30 A
V_{RRM}	200 V
T_j (max)	150 °C
V_F (typ)	0.70 V
t_{rr} (typ)	25 ns

FEATURES AND BENEFITS

- Suited for welding and high power equipment
- Very low forward losses
- Low recovery times
- High surge current capability
- Insulated:
Insulating voltage = 2500 V_{RMS}
Capacitance < 45 pF
- Low leakage current



DESCRIPTION

Dual center tap rectifier suited for welding equipment and high power industrial application. Packaged in ISOTOP, this device is intended for use in the secondary rectification of power converters.

ABSOLUTE RATINGS (limiting values, per diode)

Symbol	Parameter			Value	Unit
V_{RRM}	Repetitive peak reverse voltage			200	V
$I_{F(RMS)}$	RMS forward current		Per diode	80	A
$I_{F(AV)}$	Average forward current $\delta = 0.5$	$T_c = 115^\circ\text{C}$	Per diode	30	A
I_{FSM}	Surge non repetitive forward current	$t_p = 10 \text{ ms}$ Sinusoidal per diode		400	A
T_{stg}	Storage temperature range			- 55 + 150	°C
T_j	Maximum operating junction temperature			150	°C

STTH6102TV

THERMAL PARAMETERS

Symbol	Parameter		Maximum	Unit
$R_{th(j-c)}$	Junction to case	Per diode	1.2	°C/W
		Per device	0.65	
$R_{th(j-c)}$	Coupling		0.1	°C/W

When the diodes 1 and 2 are used simultaneously:

$$\Delta T_j (\text{diode1}) = P(\text{diode1}) \times R_{th(j-c)} (\text{per diode}) + P(\text{diode2}) \times R_{th(c)}$$

STATIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Tests conditions		Min.	Typ.	Max.	Unit
I_R^*	Reverse leakage current	$T_j = 25^\circ\text{C}$	$V_R = V_{RRM}$			50	μA
		$T_j = 125^\circ\text{C}$			25	250	
V_F^{**}	Forward voltage drop	$T_j = 25^\circ\text{C}$	$I_F = 30\text{ A}$			1.05	V
		$T_j = 25^\circ\text{C}$	$I_F = 60\text{ A}$			1.15	
		$T_j = 150^\circ\text{C}$	$I_F = 30\text{ A}$		0.70	0.81	
		$T_j = 150^\circ\text{C}$	$I_F = 60\text{ A}$			0.96	

Pulse test: * $t_p = 5\text{ms}$, $\delta < 2\%$

** $t_p = 380\mu\text{s}$, $\delta < 2\%$

To evaluate the maximum conduction losses use the following equation :

$$P = 0.66 \times I_{F(AV)} + 0.005 I_{F(RMS)}^2$$

DYNAMIC ELECTRICAL CHARACTERISTICS

Symbol	Parameter	Tests conditions		Min.	Typ.	Max.	Unit
t_{rr}	Reverse recovery time	$T_j = 25^\circ\text{C}$	$I_F = 1\text{ A}$ $V_R = 30\text{V}$ $di_F/dt = 200\text{ A}/\mu\text{s}$		25	30	ns
I_{RM}	Reverse recovery current	$T_j = 125^\circ\text{C}$	$I_F = 30\text{ A}$ $V_R = 160\text{V}$ $di_F/dt = 200\text{ A}/\mu\text{s}$		6.8	8.8	A
t_{fr}	Forward recovery time	$T_j = 25^\circ\text{C}$	$I_F = 30\text{ A}$ $di_F/dt = 200\text{ A}/\mu\text{s}$ $V_{FR} = 1.1 \times V_{Fmax}$			220	ns
V_{FP}	Forward recovery voltage	$T_j = 25^\circ\text{C}$	$I_F = 30\text{ A}$ $di_F/dt = 200\text{ A}/\mu\text{s}$		2.5		V

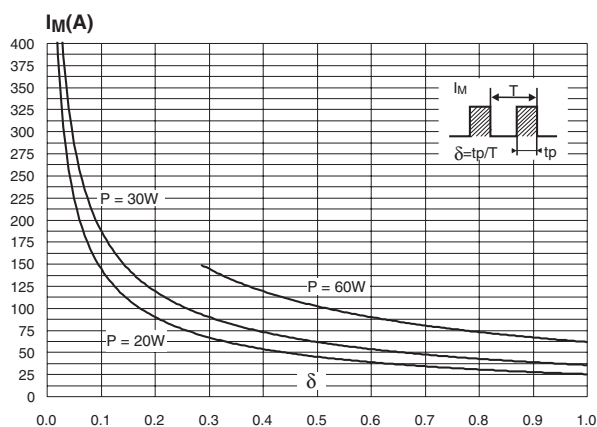
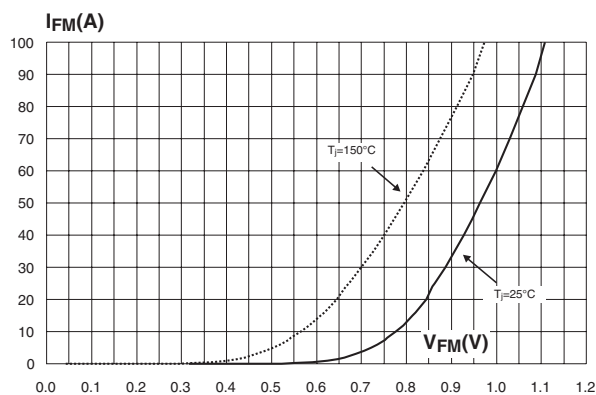
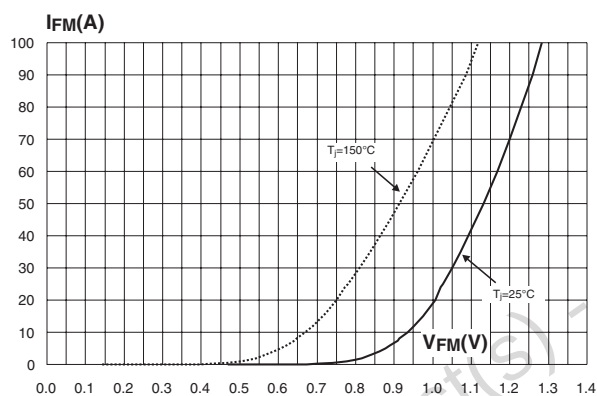
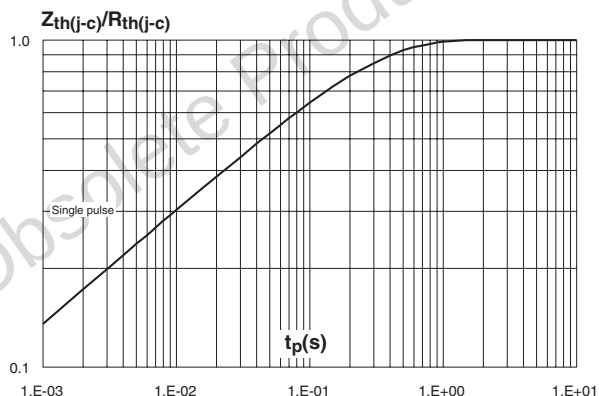
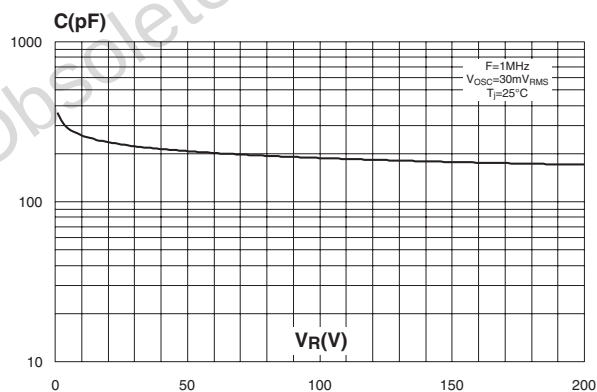
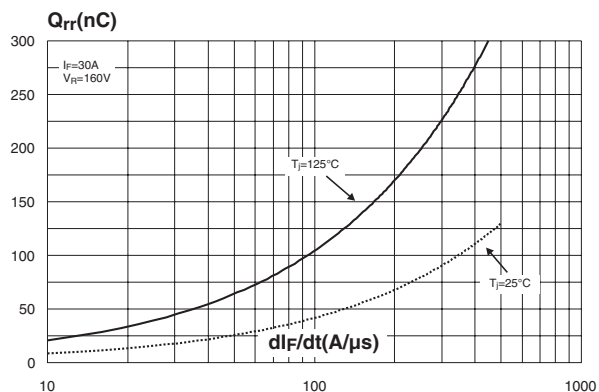
Fig. 1: Peak current versus duty cycle (per diode).**Fig. 2-1:** Forward voltage drop versus forward current (typical values, per diode).**Fig. 2-2:** Forward voltage drop versus forward current (maximum values, per diode).**Fig. 3:** Relative variation of thermal impedance junction to case versus pulse duration.**Fig. 4:** Junction capacitance versus reverse voltage applied (typical values, per diode).**Fig. 5:** Reverse recovery charges versus dl_F/dt (typical values, per diode).

Fig. 6: Reverse recovery time versus dl_F/dt (typical values, per diode).

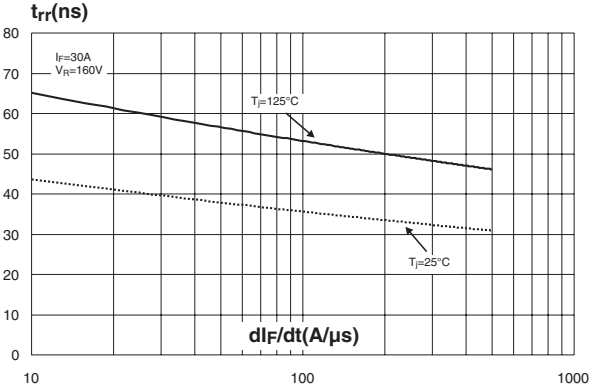


Fig. 7: Peak reverse recovery current versus dl_F/dt (typical values, per diode).

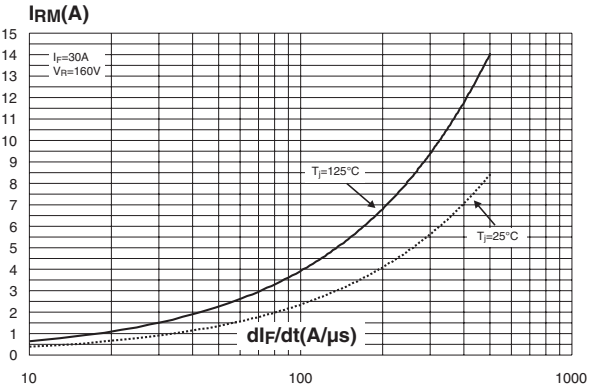
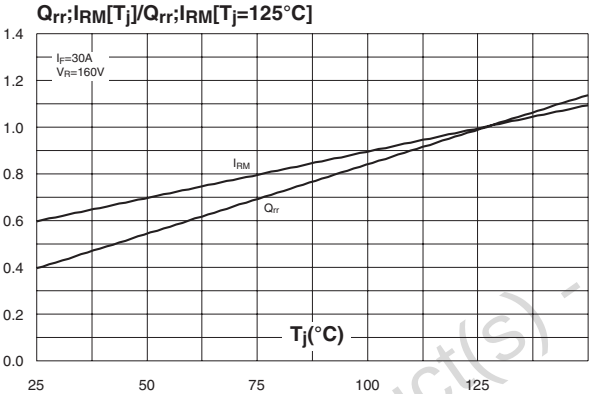
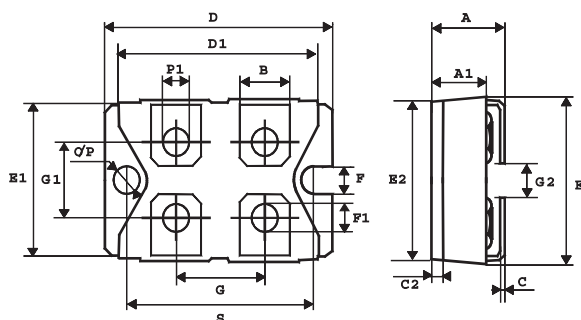


Fig. 8: Dynamic parameters versus junction temperature.



PACKAGE MECHANICAL DATA
ISOTOP


REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	11.80	12.20	0.465	0.480
A1	8.90	9.10	0.350	0.358
B	7.8	8.20	0.307	0.323
C	0.75	0.85	0.030	0.033
C2	1.95	2.05	0.077	0.081
D	37.80	38.20	1.488	1.504
D1	31.50	31.70	1.240	1.248
E	25.15	25.50	0.990	1.004
E1	23.85	24.15	0.939	0.951
E2	24.80 typ.		0.976 typ.	
G	14.90	15.10	0.587	0.594
G1	12.60	12.80	0.496	0.504
G2	3.50	4.30	0.138	0.169
F	4.10	4.30	0.161	0.169
F1	4.60	5.00	0.181	0.197
P	4.00	4.30	0.157	0.69

Ordering code	Marking	Package	Weight	Base qty	Delivery mode
STTH6102TV1	STTH6102TV1	ISOTOP	27 g (without screws)	10 (with screws)	Tube

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